



Dual Enhancement Mode Field Effect Transistor (N and P Channel)

PRODUCT SUMMARY (N-Channel)		
V _{DSS}	I _D	R _{D(S)ON} (mΩ) Max
40V	6A	26 @ V _{GS} = 10V
		33 @ V _{GS} = 4.5V

PRODUCT SUMMARY (P-Channel)		
V _{DSS}	I _D	R _{D(S)ON} (mΩ) Max
-40V	-5A	42 @ V _{GS} = -10V
		62 @ V _{GS} = -4.5V

ABSOLUTE MAXIMUM RATINGS (T_A=25°C unless otherwise noted)

Parameter	Symbol	N-Channel	P-Channel	Unit	
Drain-Source Voltage	V _{DS}	40	-40	V	
Gate-Source Voltage	V _{GS}	±20	±20	V	
Drain Current-Continuous ^a @ T _a	25°C	I _D	6	-5	A
	70°C		5.1	-4.2	A
-Pulsed ^b	I _{DM}		28	-20	A
Drain-Source Diode Forward Current ^a	I _S	1.7	-1.7	A	
Maximum Power Dissipation ^a	T _a =25°C	P _D	2	W	
	T _a =70°C		1.44		
Operating Junction and Storage Temperature Range	T _J , T _{TSG}	-55 to 150		°C	

THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Ambient ^a	R _{θJA}	62.5	°C/W
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N-Channel ELECTRICAL CHARACTERISTICS (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ ^c	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	V_{DSS}	$V_{GS}=0V, I_D=250\mu A$	40			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=32V, V_{GS}=0V$		1		μA
Gate-Body Leakage	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$		± 10		μA
ON CHARACTERISTICS ^b						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1.0	1.8	3.0	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=5A$		20	26	m ohm
		$V_{GS}=4.5V, I_D=4A$		27	33	m ohm
On-State Drain Current	$I_{D(ON)}$	$V_{DS}=5V, V_{GS}=10V$	20			A
Forward Transconductance	g_F	$V_{DS}=5V, I_D=5A$		15		S
DYNAMIC CHARACTERISTICS ^c						
Input Capacitance	C_{ISS}	$V_{DS}=20V, V_{GS}=0V$ $f=1.0MHz$		750		pF
Output Capacitance	C_{OSS}			125		pF
Reverse Transfer Capacitance	C_{RSS}			75		pF
SWITCHING CHARACTERISTICS ^c						
Turn-On Delay Time	$t_{D(ON)}$	$V_{DD}=20V$ $I_D=1A$ $V_{GS}=10V$ $R_{GEN}=3.3\text{ ohm}$		13		ns
Rise Time	t_r			11		ns
Turn-Off Delay Time	$t_{D(OFF)}$			37		ns
Fall Time	t_f			10		ns
Total Gate Charge	Q_g	$V_{DS}=24V, I_D=5A, V_{GS}=10V$		12.5		nC
		$V_{DS}=24V, I_D=5A, V_{GS}=4.5V$		6.4		nC
Gate-Source Charge	Q_{gs}	$V_{DS}=24V, I_D=5A$ $V_{GS}=4.5V$		1.8		nC
Gate-Drain Charge	Q_{gd}			3.6		nC

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P-Channel ELECTRICAL CHARACTERISTICS (TA=25 C° unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ ^c	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =-250μA	-40			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-32V, V _{GS} =0V		-1		μA
Gate-Body Leakage	I _{GSS}	V _{GS} =±20V, V _{DS} =0V		±10		μA
ON CHARACTERISTICS^b						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250μA	-1.0	-1.8	-3.0	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D = -4A		35	42	m ohm
		V _{GS} =-4.5V, I _D = -3A		54	62	m ohm
On-State Drain Current	I _{D(ON)}	V _{DS} =-5V, V _{GS} = -10V	16			A
Forward Transconductance	g _{FS}	V _{DS} =-5V, I _D = - 4A		10		S
DYNAMIC CHARACTERISTICS^c						
Input Capacitance	C _{ISS}	V _{DS} =-20V, V _{GS} =0V f=1.0MHz		960		PF
Output Capacitance	C _{OSS}			142		PF
Reverse Transfer Capacitance	C _{RSS}			75		PF
SWITCHING CHARACTERISTICS^c						
Turn-On Delay Time	t _{D(ON)}	V _D =-20V I _D =-1A V _{GEN} = -10V R _{GEN} = 3.3 ohm		15		ns
Rise Time	t _r			13		ns
Turn-Off Delay Time	t _{D(OFF)}			66		ns
Fall Time	t _f			25		ns
Total Gate Charge	Q _g	V _{DS} =-24V, I _D =-4A, V _{GS} =-10V		15.6		nC
		V _{DS} =-24V, I _D =-4A, V _{GS} =-4.5V		7.7		nC
Gate-Source Charge	Q _{gs}	V _{DS} =-24V, I _D = - 4A V _{GS} =-4.5V		2.3		nC
Gate-Drain Charge	Q _{gd}			4.3		nC

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ELECTRICAL CHARACTERISTICS ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ ^c	Max	Unit
DRAIN-SOURCE DIODE CHARACTERISTICS ^b						
Diode Forward Voltage	V_{SD}	$V_{GS} = 0\text{V}, I_S = 1.7\text{A}$ $V_{GS} = 0\text{V}, I_S = -1.7\text{A}$	N-Ch	0.78	1.2	V
			P-Ch	-0.77	-1.2	

Notes

- a. Surface Mounted on FR4 Board, $t \leq 10\text{sec}$.
- b. Pulse Test: Pulse Width $\leq 300\text{\mu s}$, Duty Cycle $\leq 2\%$.
- c. Guaranteed by design, not subject to production testing.

N-Channel

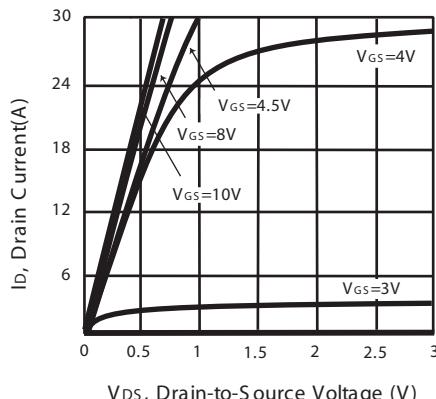


Figure 1. Output Characteristics

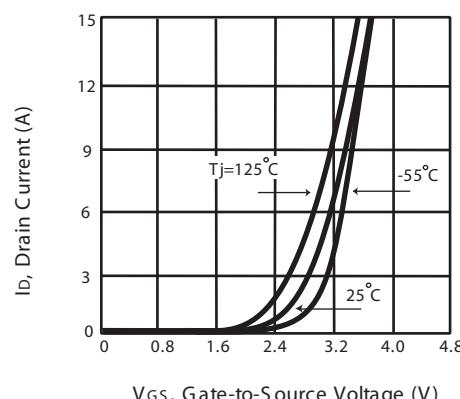


Figure 2. Transfer Characteristics

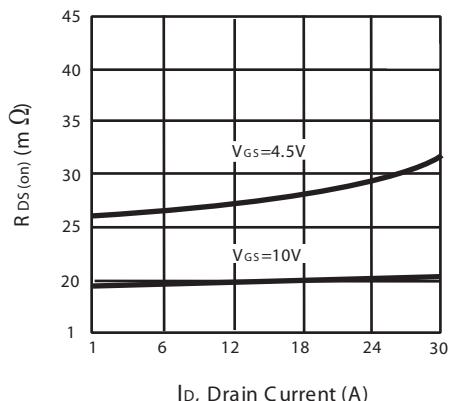


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

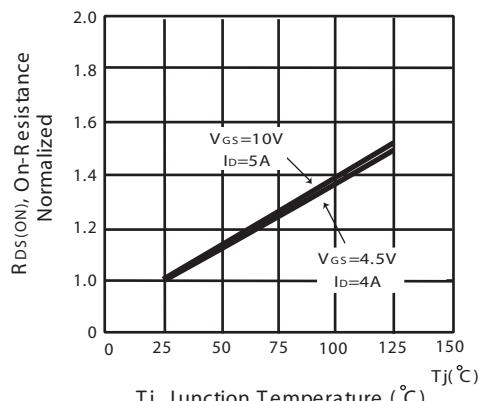


Figure 4. On-Resistance Variation with Drain Current and Temperature

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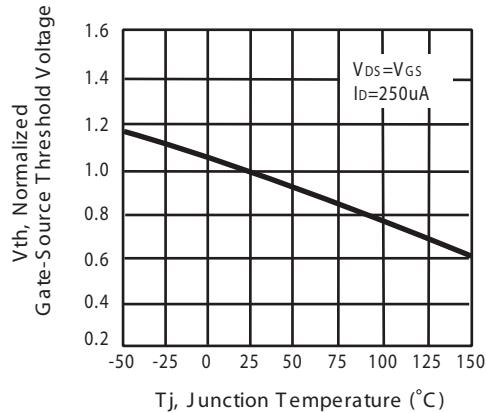


Figure 5. Gate Threshold Variation with Temperature

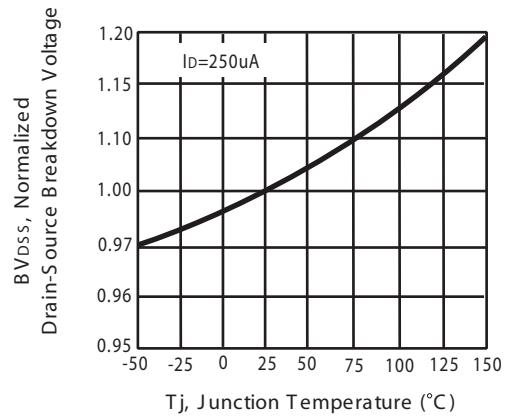


Figure 6. Breakdown Voltage Variation with Temperature

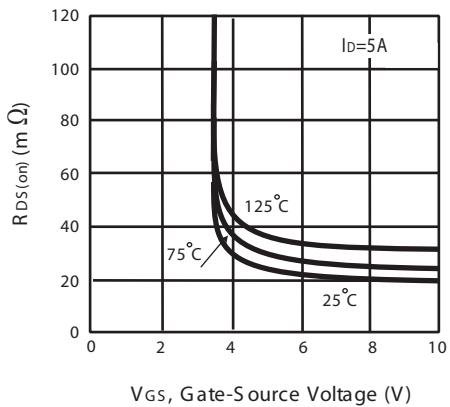


Figure 7. On-Resistance vs. Gate-Source Voltage

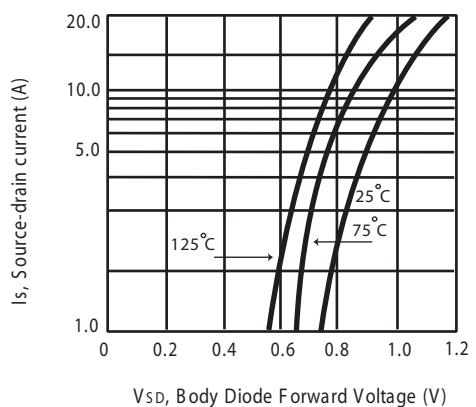


Figure 8. Body Diode Forward Voltage Variation with Source Current

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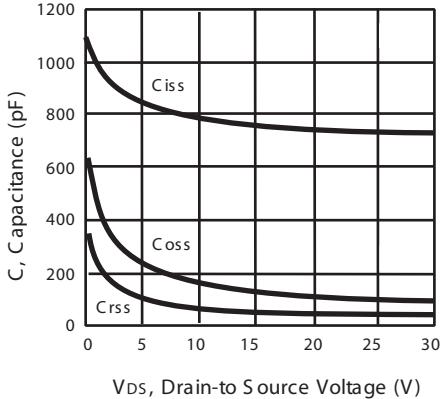


Figure 9. Capacitance

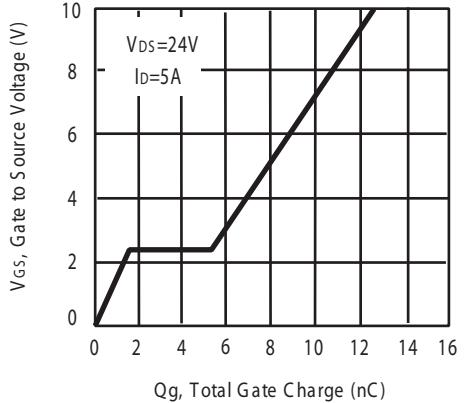


Figure 10. Gate Charge

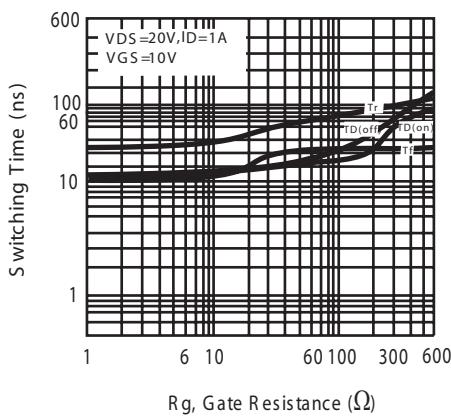


Figure 11. switching characteristics

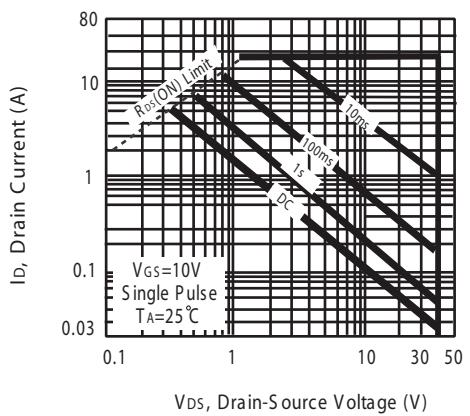
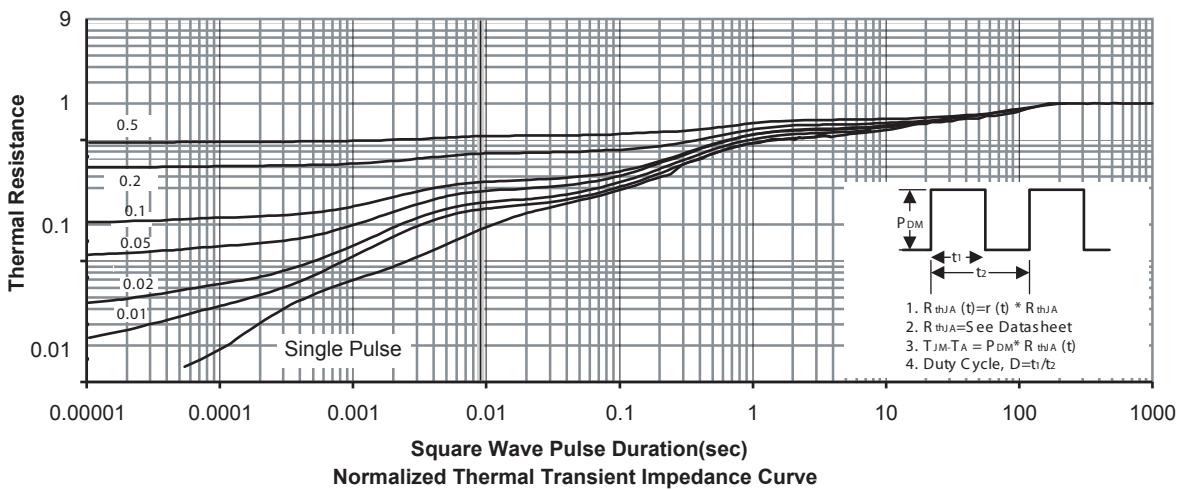


Figure 12. Maximum Safe Operating Area



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P-Channel

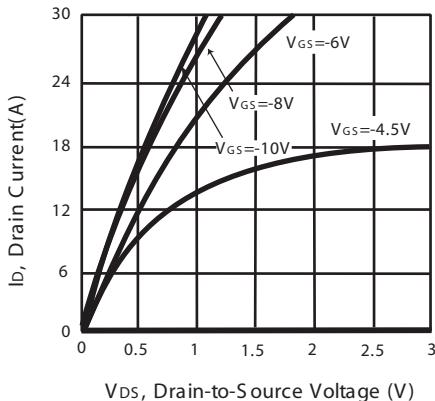


Figure 1. Output Characteristics

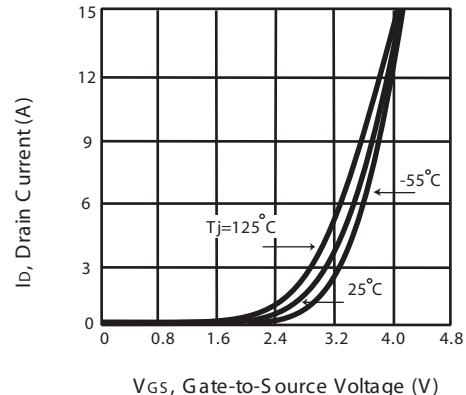


Figure 2. Transfer Characteristics

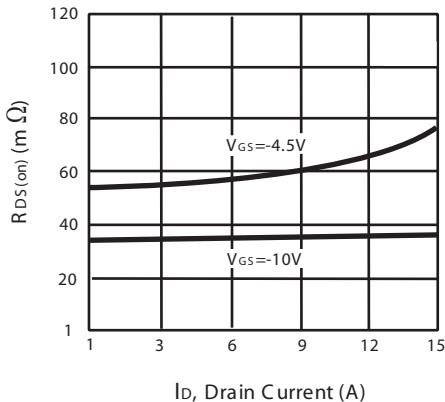


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

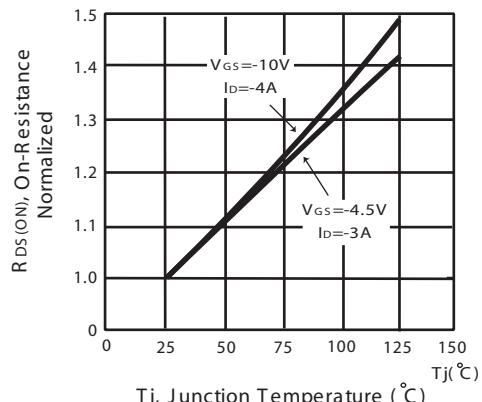


Figure 4. On-Resistance Variation with Drain Current and Temperature

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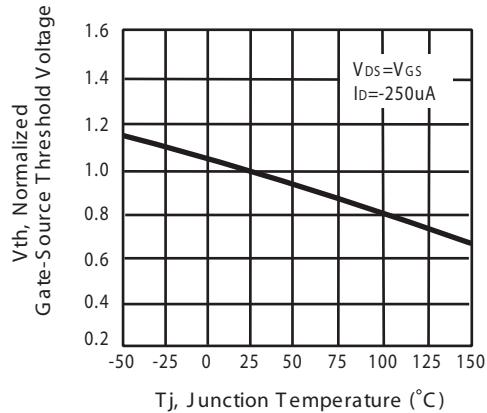


Figure 5. Gate Threshold Variation with Temperature

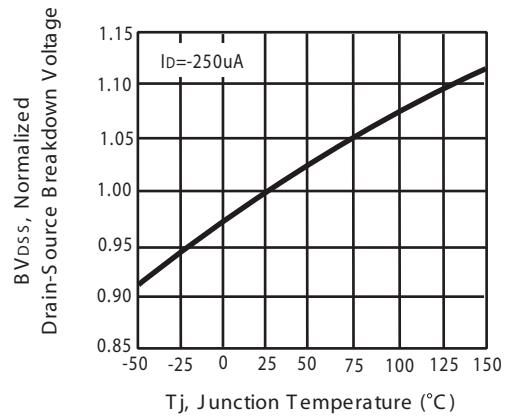


Figure 6. Breakdown Voltage Variation with Temperature

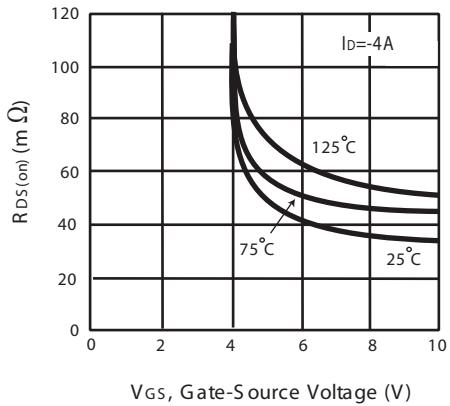


Figure 7. On-Resistance vs. Gate-Source Voltage

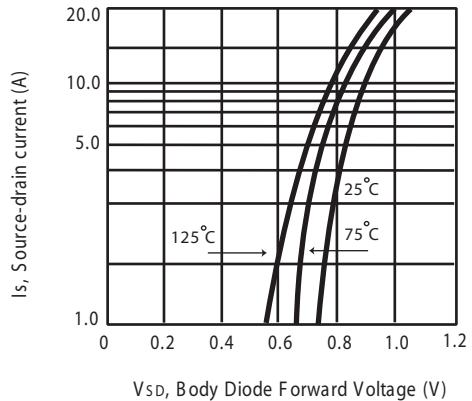


Figure 8. Body Diode Forward Voltage Variation with Source Current

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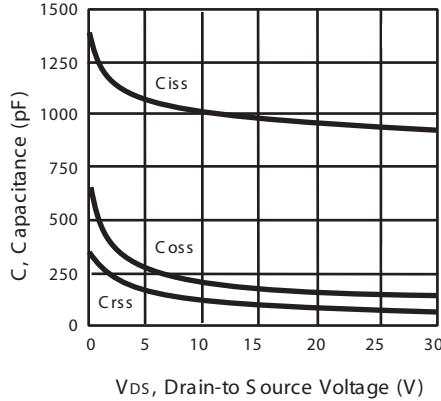


Figure 9. Capacitance

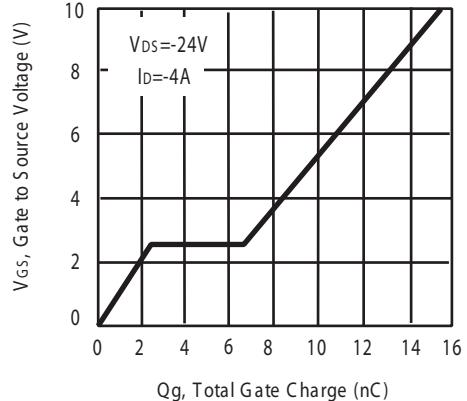


Figure 10. Gate Charge

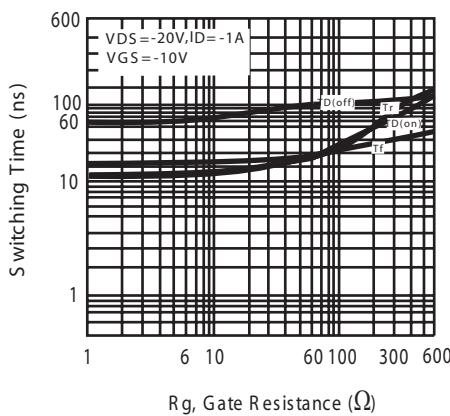


Figure 11. switching characteristics

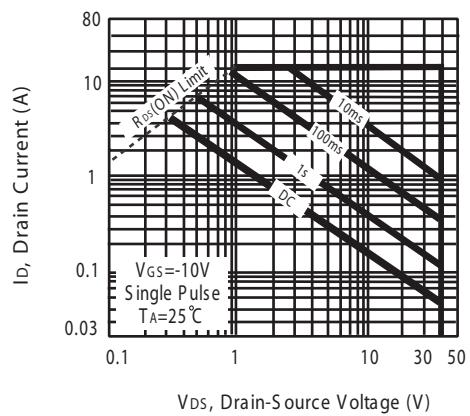
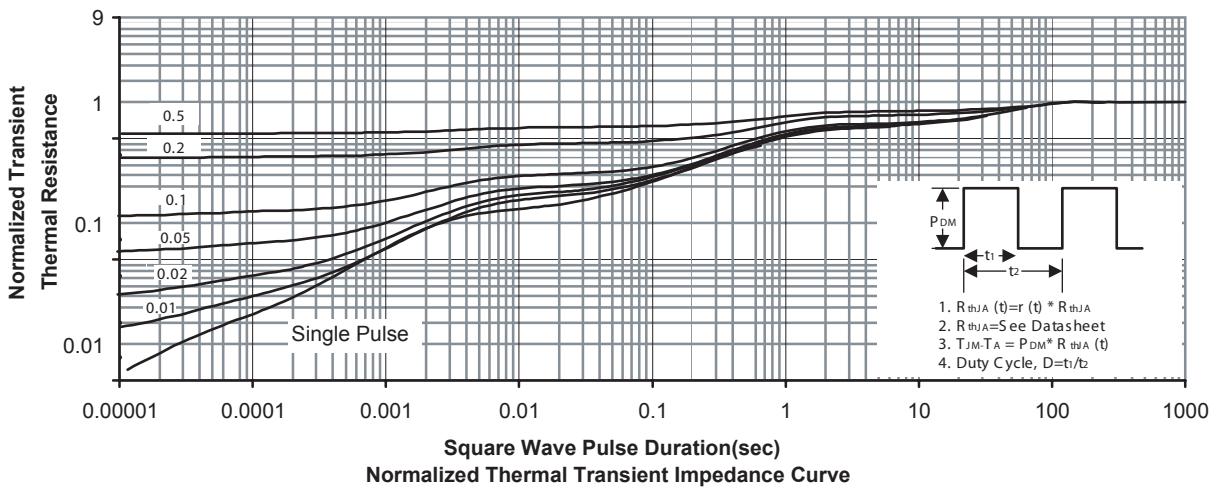


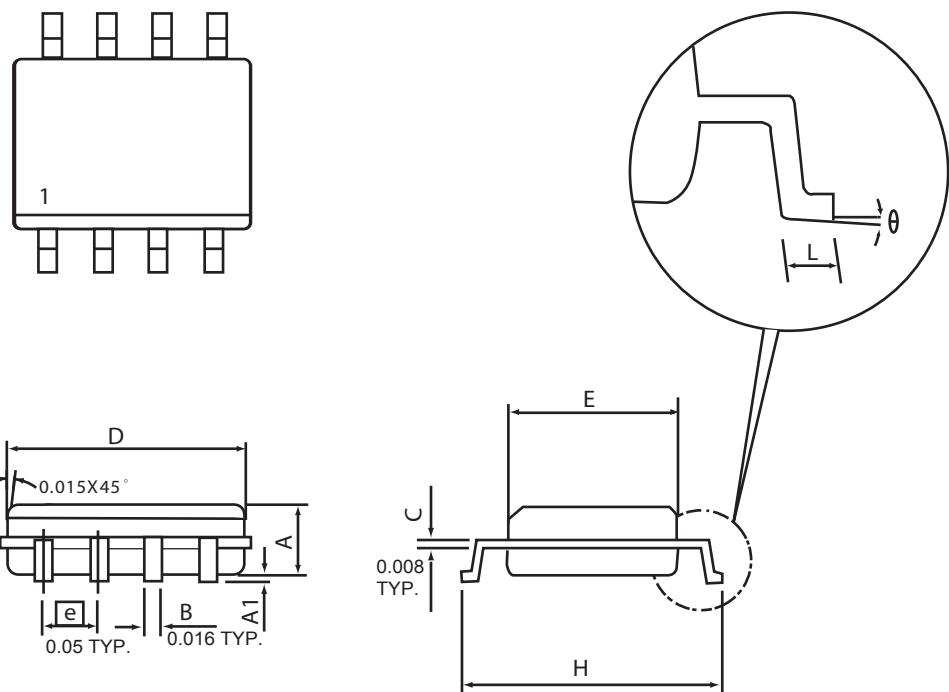
Figure 12. Maximum Safe Operating Area



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PACKAGE OUTLINE DIMENSIONS

SO-8

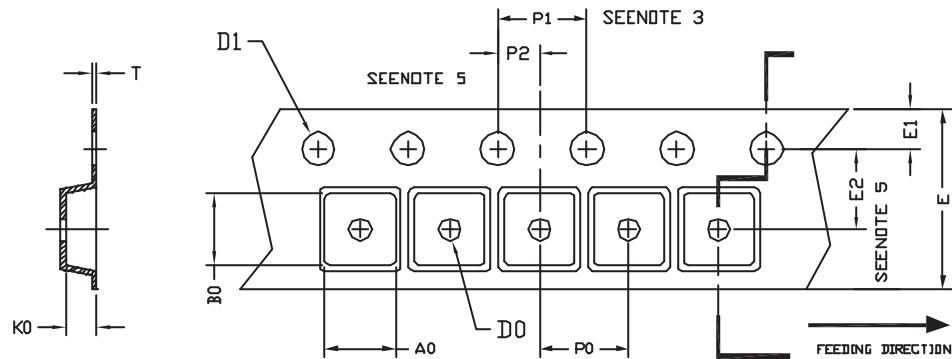


SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.35	1.75	0.053	0.069
A1	0.10	0.25	0.004	0.010
D	4.80	4.98	0.189	0.196
E	3.81	3.99	0.150	0.157
H	5.79	6.20	0.228	0.244
L	0.41	1.27	0.016	0.050
θ	0°	8°	0°	8°

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SO-8 Tape and Reel Data

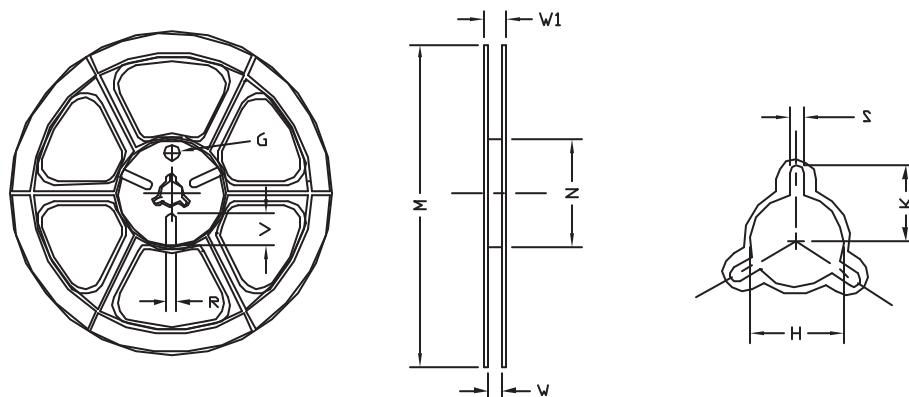
SO-8 Carrier Tape



unit:mm

PACKAGE	A0	B0	K0	D0	D1	E	E1	E2	P0	P1	P2	T
SOP 8N 150mil	6.40	5.20	2.10	$\phi 1.5$ (MIN)	$\phi 1.5$ $+ 0.1$ $- 0.0$	12.0 ± 0.3	1.75	5.5 ± 0.05	8.0	4.0	2.0 ± 0.05	0.3 ± 0.05

SO-8 Reel



UNIT:mm

TAPE SIZE	REEL SIZE	M	N	W	W1	H	K	S	G	R	V
12 mm	$\phi 330$	330 ± 1	62 ± 1.5	12.4 $+ 0.2$	16.8 $- 0.4$	$\phi 12.75$ $+ 0.15$	---	2.0 ± 0.15	---	---	---